# Sound Processor for Car Audio with Built-in High-Voltage Amplifier and $2^{\text {nd }}$ Order Post Filter 

## BD37069FV-M

## General Description

BD37069FV-M is a sound processor developed for car audio with built-in selector of six stereo inputs and output interfaced to ADC after adjusting signal level.
BD37069FV-M has a 6-channel volume circuit and built-in $2^{\text {nd }}$ order post filter which reduces the out-of -band noise. The High-Voltage function is capable to reach up to $5.2 \mathrm{~V}_{\text {RMS }}$ maximum output. Furthermore, the IC is simple to design due to the built-in TDMA noise reduction systems.

## Features

- AEC-Q100 Qualified ${ }^{\text {(Note1) }}$
- Built-in differential input selector that can select single-ended / differential input
- Reduce switching pop noise of input gain control due to the built-in advanced switch circuit
- Less out-of-band noise of DAC by built-in $2^{\text {nd }}$ order post filter
- Built-in buffered ground isolation amplifier to achieve high CMRR characteristics
- Built-in TDMA noise reduction circuit reduces the additional components for external filter
- Available to output $5.2 \mathrm{~V}_{\text {RMs }}$ by High-Voltage function (This device is possible to $3.2 \mathrm{~V}_{\text {RMS }}$ output by using another High-Voltage mode, $\mathrm{VCCH}=11.5 \mathrm{~V}$ )
- Available to control by $3.3 \mathrm{~V} / 5 \mathrm{~V}$ for $\mathrm{I}^{2} \mathrm{C}$-bus controller
- The input and output terminals are located together to arrange the flow of signal in a same direction making the PCB layout easier and PCB area smaller
(Note 1) Grade 3

| Key Specifications ${ }^{\text {(Note2) }}$ |  |
| :--- | ---: |
| ■Total Harmonic Distortion: | $0.003 \%(\mathrm{Typ})$ |
| ■Maximum Input Voltage: | $2.1 \mathrm{~V}_{\mathrm{RMS}}(\mathrm{Typ})$ |
| ■Common Mode Rejection Ratio : | $55 \mathrm{~dB}(\mathrm{Min})$ |
| ■Maximum Output Voltage: | $5.2 \mathrm{~V}_{\mathrm{R} M S}(\mathrm{Typ})$ |
| ■Output Noise Voltage: | $23 \mu \mathrm{~V}_{\mathrm{R} M \mathrm{~S}}(\mathrm{Typ})$ |
| ■Residual Output Noise Voltage: | $10.5 \mu \mathrm{~V}_{\mathrm{RMS}}(\mathrm{Typ})$ |
| ■Ripple Rejection Ratio: | $-70 \mathrm{~dB}(\mathrm{Typ})$ |
| ■Operating Temperature Range: | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| (Note2)These specifications are High-Voltage mode2. |  |

## Package

SSOP-B40
W(Typ) $\times \mathrm{D}$ (Typ) $\times \mathrm{H}($ Max)
$13.60 \mathrm{~mm} \times 7.80 \mathrm{~mm} \times 2.00 \mathrm{~mm}$


## Applications

Car Audio and Other Audio Equipment

## Typical Application Circuit



Figure 1. Typical Application Circuit

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## Pin Configuration



Figure 2.Pin Configuration
Pin Descriptions

| Pin No. | Pin Name | Description | Pin No. | Pin Name | Description |
| :---: | :---: | :--- | :---: | :---: | :--- |
| 1 | A1 | A input terminal of 1ch | 21 | VCCH | VCCH terminal for power supply |
| 2 | A2 | A input terminal of 2ch | 22 | SCL | I $^{2}$ C-bus clock terminal |
| 3 | B1 | B input terminal of 1ch | 23 | SDA | I $^{2}$ C-bus data terminal |
| 4 | B2 | B input terminal of 2ch | 24 | GND | GND terminal |
| 5 | CP1 | C positive input terminal of 1ch | 25 | VREF | BIAS terminal |
| 6 | CN | C negative input terminal | 26 | VCCL | VCCL terminal for power supply |
| 7 | CP2 | C positive input terminal of 2ch | 27 | IG2 | Input gain output terminal of 2ch |
| 8 | DP1 | D positive input terminal of 1ch | 28 | IG1 | Input gain output terminal of 1ch |
| 9 | DN | D negative input terminal | 29 | INC | Center input terminal |
| 10 | DP2 | D positive input terminal of 2ch | 30 | INS | Subwoofer input terminal |
| 11 | EP1 | E positive input terminal of 1ch | 31 | INR1 | Rear input terminal of 1ch |
| 12 | EN | E negative input terminal | 32 | INR2 | Rear input terminal of 2ch |
| 13 | EP2 | E positive input terminal of 2ch | 33 | INF1 | Front input terminal of 1ch |
| 14 | FP1 | F positive input terminal of 1ch | 34 | INF2 | Front input terminal of 2ch |
| 15 | FN1 | F negative input terminal of 1ch | 35 | OUTF2 | Front output terminal of 2ch |
| 16 | FN2 | F negative input terminal of 2ch | 36 | OUTF1 | Front output terminal of 1ch |
| 17 | FP2 | F positive input terminal of 2ch | 37 | OUTR2 | Rear output terminal of 2ch |
| 18 | MIN | Mixing input terminal | 38 | OUTR1 | Rear output terminal of 1ch |
| 19 | SEL | High Voltage output mode Select | 39 | OUTS | Subwoofer output terminal |
| 20 | HIVOLB | Output Gain control terminal | 40 | OUTC | Center output terminal |

## Block Diagram



Figure 3. Block Diagram

- The outputs of Pin 27 and Pin 28 are selected by the input selector, from the inputs Pin 1 to Pin 17.

Otherwise, these signals are possible to output directly on Pin 35 to Pin 40.

- 6-channel input signals from DSP on Pin 29 to Pin 34 pass through the volume circuit (Fader) and $2^{\text {nd }}$ order post filter to the output terminals Pin 35 to Pin 40 .
- It is possible for 6 -channel inputs to set the gain up to +6 dB by Gain adjust function and to set the gain up to +8.3 dB by Level Shift Circuit (High-Voltage Mode).

| Parameter | Symbol |  | Rating | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Power Supply Voltage | $\mathrm{V}_{\text {CCL }}$ |  | 10 | V |
|  | $\mathrm{V}_{\mathrm{CCH}}$ |  | 18 | V |
| Input Voltage | VIN | SCL, SDA | GND-0.3 to +7 | V |
|  |  | Other | GND-0.3 to $\mathrm{V}_{\text {ccL }}+0.3$ |  |
| Storage Temperature | $\mathrm{T}_{\text {STG }}$ |  | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Maximum Junction Temperature | $\mathrm{T}_{\text {JMAX }}$ |  | +150 | ${ }^{\circ} \mathrm{C}$ |

Caution: Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins and the internal circuitry. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.

Thermal Resistance ${ }^{\text {(Note 1) }}$

| Parameter | Symbol | Thermal Resistance (Typ) |  | Unit |
| :---: | :---: | :---: | :---: | :---: |
|  |  | 1s ${ }^{\text {(Note 3) }}$ | $2 \mathrm{~s} 2 \mathrm{p}^{\text {(Note 4) }}$ |  |
| SSOP-B40 |  |  |  |  |
| Junction to Ambient | $\theta_{\text {JA }}$ | 103.6 | 58.8 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Junction to Top Characterization Parameter ${ }^{\text {(Note 2) }}$ | $\Psi_{J T}$ | 17 | 10 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

(Note 1)Based on JESD51-2A(Still-Air)
(Note 2)The thermal characterization parameter to report the difference between junction temperature and the temperature at the top center of the outside surface of the component package.
(Note 3)Using a PCB board based on JESD51-3.
(Note 4)Using a PCB board based on JESD51-7

| Layer Number of <br> Measurement Board | Material | Board Size |
| :---: | :---: | :---: |
| Single | FR-4 | $114.3 \mathrm{~mm} \times 76.2 \mathrm{~mm} \times 1.6 \mathrm{mmt}$ |
| Top |  |  |
| Copper Pattern | Thickness |  |
| Footprints and Traces | $70 \mu \mathrm{~m}$ |  |


| Layer Number of <br> Measurement Board | Material | Board Size |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 4 Layers | FR-4 | $114.3 \mathrm{~mm} \times 76.2 \mathrm{~mm} \times 1.6 \mathrm{mmt}$ |  |  |  |
| Top |  | 2 Internal Layers |  | Bottom |  |
| Copper Pattern | Thickness | Copper Pattern | Thickness | Copper Pattern | Thickness |
| Footprints and Traces | $70 \mu \mathrm{~m}$ | $74.2 \mathrm{~mm} \times 74.2 \mathrm{~mm}$ | $35 \mu \mathrm{~m}$ | $74.2 \mathrm{~mm} \times 74.2 \mathrm{~mm}$ | $70 \mu \mathrm{~m}$ |

Recommended Operating Condition ( $\mathrm{Ta}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ )

| Parameter | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Power Supply Voltage | $\mathrm{V}_{\mathrm{CLL}}$ | 7.0 | 9 | 9.5 | V |
|  | $\mathrm{~V}_{\mathrm{CCH}}$ | $\mathrm{V}_{\mathrm{CCL}}$ | 17 | 17.8 | V |

## Electrical Characteristics

Unless otherwise specified, $\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CCL}}=9 \mathrm{~V}, \mathrm{~V}_{\mathrm{CCH}}=17 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}, \mathrm{V}_{\mathrm{IN}}=1 \mathrm{~V}_{\mathrm{RMS}}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$,
Input selector A, Input Gain OdB, Gain Adjust +6dB, High-Voltage ON (High-Voltage mode2), LPF ON, Fader OdB, Input point=A1/A2, Monitor point=IG1/IG2

| $\begin{aligned} & \text { 등 } \\ & \text { 응 } \end{aligned}$ | Parameter | Symbol | Limit |  |  | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |  |
| ¢ | Current Consumption (VCCL) | $\mathrm{l}_{\mathrm{Q} \text { _VCCL }}$ | - | 30 | 43 | mA | No signal |
|  | Current Consumption (VCCH) | $\mathrm{l}_{\mathrm{Q}} \mathrm{VcCH}$ | - | 7 | 10 | mA | No signal |
|  | Input Impedance (A) | Rin_s | 70 | 100 | 130 | k $\Omega$ |  |
|  | Input Impedance (B, C, D, E, F) | RIN_D | 175 | 250 | 325 | k $\Omega$ |  |
|  | Voltage Gain | $\mathrm{G}_{V}$ | -1.5 | 0 | 1.5 | dB | $\mathrm{G}_{\mathrm{V}}=20 \log \left(\mathrm{~V}_{\text {Out }} / \mathrm{V}_{\text {IN }}\right)$ |
|  | Channel Balance | CB | -1.5 | 0 | 1.5 | dB | $\mathrm{CB}=\mathrm{G}_{\mathrm{V} 1}-\mathrm{G}_{\mathrm{V} 2}$ |
|  | Total Harmonic Distortion | THD+N | - | 0.003 | 0.05 | \% | $\begin{aligned} & \text { VOUT }=1 V_{\text {RMS }} \\ & B W=400-30 \mathrm{kHz} \end{aligned}$ |
|  | Output Noise Voltage ${ }^{(\text {Note 1) }}$ | $\mathrm{V}_{\text {NO1 }}$ | - | 3.1 | 8.0 | $\mu \mathrm{V}_{\text {RMS }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{G}}=0 \Omega \\ & \mathrm{BW}=1 \mathrm{HF}-\mathrm{A} \end{aligned}$ |
|  | Maximum Input Voltage | Vıм | 2.0 | 2.2 | - | $V_{\text {RMS }}$ | $\begin{aligned} & \mathrm{V}_{\text {IM }} \text { at THD }+\mathrm{N}\left(\mathrm{~V}_{\text {Out }}\right)=1 \% \\ & \mathrm{BW}=400-30 \mathrm{kzz} \end{aligned}$ |
|  | Crosstalk Between Channels ${ }^{\text {(Note1) }}$ | CTC | - | -100 | -90 | dB | $\begin{aligned} & \mathrm{R}_{\mathrm{G}}=0 \Omega \\ & \mathrm{CTC}=20 \log \left(\mathrm{~V}_{\text {out }} / \mathrm{V}_{\text {Out }}\right) \\ & \mathrm{BW}=1 \mathrm{HF}-\mathrm{A} \end{aligned}$ |
|  | Crosstalk Between Selectors ${ }^{(\text {Note1) }}$ | CTS | - | -100 | -90 | dB | $\begin{aligned} & \mathrm{R}_{\mathrm{G}}=0 \Omega \\ & \mathrm{CTS}=20 \log \left(\mathrm{~V}_{\text {OUT }} / \mathrm{V}_{\text {OUT' }}\right) \\ & \mathrm{BW}=1 \mathrm{HF}-\mathrm{A} \end{aligned}$ |
|  | Common Mode Rejection Ratio (C, D, E, F) ${ }^{\text {(Note1) }}$ | CMRR | 55 | 65 | - | dB | XP1 and XN input XP2 and XN input CMRR $=20 \log \left(V_{\text {IN }} / V_{\text {OUT }}\right)$ $\mathrm{BW}=\mathrm{IHF}-\mathrm{A},[\mathrm{X}=\mathrm{C}, \mathrm{D}, \mathrm{E}, \mathrm{~F}]$ |
|  | Minimum Input Gain | $\mathrm{GIN}_{\text {_min }}$ | -17 | -15 | -13 | dB | $\begin{aligned} & \text { Input Gain }=-15 \mathrm{~dB} \\ & \mathrm{~V}_{\text {IN }}=0.1 \mathrm{~V}_{\text {RMS }} \\ & \mathrm{G}_{\text {IN }}=20 \log \left(\mathrm{~V}_{\text {OUT }} / V_{\text {IN }}\right) \end{aligned}$ |
|  | Maximum Input Gain | GIn_max | 21 | 23 | 25 | dB | $\begin{aligned} & \text { Input Gain }=23 \mathrm{~dB} \\ & V_{\text {IN }}=0.1 \mathrm{~V}_{\text {RMS }} \\ & \mathrm{G}_{\text {IN }}=202 \log \left(V_{\text {OUT }} / V_{\text {IN }}\right) \end{aligned}$ |
|  | Gain Set Error | $\mathrm{GIN}_{\text {_ }}$ ERR | -2 | 0 | +2 | dB | Input Gain $=-15$ to +23 dB |
|  | Output Impedance | Rout | - | - | 50 | $\Omega$ |  |
|  | Maximum Output Voltage | Vом | 2.0 | 2.2 | - | $V_{\text {RMS }}$ | $\begin{aligned} & \text { THD }+\mathrm{N}=1 \% \\ & \text { BW }=400-30 \mathrm{kHz} \end{aligned}$ |

[^0]Unless otherwise specified, $\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CCL}}=\mathrm{V}_{\mathrm{CCH}}=9 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}, \mathrm{V}_{\mathrm{IN}}=0.9 \mathrm{~V}_{\mathrm{RMS}}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$,
Input selector A, Input Gain OdB, Gain Adjust +6dB, High-Voltage OFF(normal mode), LPF ON, Fader OdB,
Input point=INF1/INF2/INR1/INR2/INC/INS, Monitor point=OUTF1/OUTF2/OUTR1/OUTR2/OUTC/OUTS

|  | Parameter | Symbol | Limit |  |  | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 응 |  |  | Min | Typ | Max |  |  |
|  | Output Impedance | Rout | - | - | 50 | $\Omega$ |  |
|  | * Maximum Output Voltage | Vом | 2.3 | 2.5 | - | $V_{\text {RMS }}$ | $\begin{aligned} & V_{\text {IN }}=1 V_{\text {RMS }} \\ & T H D+N=1 \% \\ & B W=400-30 \mathrm{kHz} \end{aligned}$ |
|  | *Output Gain | $\mathrm{G}_{\mathrm{H} \text { (OUT) }}$ | 0.5 | 2 | 3.5 | dB | $\mathrm{G}_{\text {H(OUT })}=20 \log \left(\mathrm{~V}_{\text {OUT }} / \mathrm{V}_{\text {IN }}\right)$ |

Whis Item is designated by ROHM only to discriminate between other items and it.
Unless otherwise specified, $\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CLL}}=9 \mathrm{~V}, \mathrm{~V}_{\mathrm{CCH}}=11.5 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}, \mathrm{V}_{\mathbb{I N}}=0.9 \mathrm{~V}_{\mathrm{RMS}}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$,
Input selector A, Input Gain OdB, Gain Adjust +6dB, High-Voltage ON(High-Voltage mode1), LPF ON, Fader OdB, Input point=INF1/INF2/INR1/INR2/INC/INS, Monitor point=OUTF1/OUTF2/OUTR1/OUTR2/OUTC/OUTS

| 등응 | Parameter | Symbol | Limit |  |  | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |  |
|  | Output Impedance | Rout | - | - | 50 | $\Omega$ |  |
|  | \$Maximum Output Voltage | Vом | 3.2 | 3.4 | - | VRms | $\begin{aligned} & \mathrm{V}_{\text {IN }}=1 \mathrm{~V}_{\text {RMS }} \\ & \mathrm{THD}+\mathrm{N}=1 \% \\ & \mathrm{BW}=400-30 \mathrm{kHz} \end{aligned}$ |
|  | $\underset{\sim}{\sim}$ Output Gain | $\mathrm{G}_{\mathrm{H} \text { (OUT) }}$ | 2.6 | 4.6 | 6.6 | dB | $\mathrm{G}_{\mathrm{H}(\mathrm{OUT})}=20 \log \left(\mathrm{~V}_{\text {OUT }} / \mathrm{V}_{\text {IN }}\right)$ |

$\tilde{\sim}$ This Item is designated by ROHM only to discriminate between other items and it.
Unless otherwise specified, $\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CCL}}=9 \mathrm{~V}, \mathrm{~V}_{\mathrm{CcH}}=17 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}, \mathrm{V}_{\mathrm{IN}}=0.9 \mathrm{~V}_{\mathrm{RMS}}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$,
Input selector A, Input Gain 0dB, Gain Adjust +6 dB , High-Voltage ON(High-Voltage mode2), LPF ON, Fader OdB, Input point=INF1/INF2/INR1/INR2/INC/INS, Monitor point=OUTF1/OUTF2/OUTR1/OUTR2/OUTC/OUTS

|  | Parameter | Symbol | Limit |  |  | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 응 |  |  | Min | Typ | Max |  |  |
|  | Output Impedance | Rout | - | - | 50 | $\Omega$ |  |
|  | * Maximum Output Voltage | Vом | 5.0 | 5.2 | - | $\mathrm{V}_{\text {RMS }}$ | $\begin{aligned} & \mathrm{V}_{\text {IN }}=1 \mathrm{~V}_{\text {RMS }} \\ & \mathrm{THD}+\mathrm{N}=1 \% \\ & \mathrm{BW}=400-30 \mathrm{kHz} \end{aligned}$ |
|  | Output Gain | $\mathrm{G}_{\mathrm{H} \text { (OUT) }}$ | 6.3 | 8.3 | 10.3 | dB | $\mathrm{G}_{\mathrm{H}(\mathrm{OUT})}=20 \log \left(\mathrm{~V}_{\text {OUT }} / \mathrm{V}_{\text {IN }}\right)$ |

WThis Item is designated by ROHM only to discriminate between other items and it.

Unless otherwise specified, $\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CcL}}=9 \mathrm{~V}, \mathrm{~V}_{\mathrm{CCH}}=17 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}, \mathrm{V}_{\mathrm{IN}}=0.9 \mathrm{~V}_{\mathrm{RMS}}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$,
Input selector A, Input Gain OdB, Gain Adjust +6 dB , High-Voltage ON(High-Voltage mode2), LPF ON, Fader 0dB, Input point=INF1/INF2/INR1/INR2/INC/INS, Monitor point=OUTF1/OUTF2/OUTR1/OUTR2/OUTC/OUTS

| 응 | Parameter | Symbol | Limit |  |  | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |  |
|  | Maximum Boost Gain | $\mathrm{G}_{\mathrm{F} \text { BST }}$ | 21 | 23 | 25 | dB | $\begin{aligned} & \text { Fader Boost Gain }=+23 \mathrm{~dB} \\ & V_{\text {IN }}=0.1 V_{\text {RMS }} \\ & \mathrm{G}_{\mathrm{F}}=20 \log \left(\mathrm{~V}_{\text {ouT }} / V_{\text {IN }}\right)-\mathrm{G}_{\mathrm{H}(\text { OUT })} \\ & \text { Gain Adjust }^{2} \mathrm{~dB} \end{aligned}$ |
|  | Channel Balance | CB | -1.5 | 0 | 1.5 | dB | $\mathrm{CB}=\mathrm{GV} 1-\mathrm{GV} 2$ |
|  | Total Harmonic Distortion | THD+N | - | 0.003 | 0.05 | \% | $\begin{aligned} & \text { BW }=400-30 \mathrm{kHz} \\ & \text { Gain Adjust }=0 \mathrm{~dB} \end{aligned}$ |
|  | Output Noise Voltage ${ }^{\text {(Note1) }}$ | $\mathrm{V}_{\mathrm{NO} 1}$ | - | 23 | 40 | $\mu \mathrm{V}_{\text {RMS }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{G}}=0 \Omega \\ & \mathrm{BW}=\mathrm{IHF}-\mathrm{A} \end{aligned}$ |
|  | Residual Output Noise Voltage (Note1) | $\mathrm{V}_{\text {NOR }}$ | - | 10.5 | 20 | $\mu \mathrm{V}_{\text {RMS }}$ | $\begin{aligned} & \text { Fader Attenuation }=\quad-\infty \mathrm{dB} \\ & \mathrm{R}_{\mathrm{G}}=0 \Omega \\ & \mathrm{BW}=1 \mathrm{HF}-\mathrm{A} \end{aligned}$ |
|  | Maximum Input Voltage | VIM | 2.0 | 2.1 | - | VRMS | $\begin{aligned} & V_{\text {IM }} \text { at } T H D+N\left(V_{\text {out }}\right)=1 \% \\ & B W=400-30 \mathrm{kHz} \\ & \text { Gain Adjust }=0 \mathrm{~dB} \end{aligned}$ |
|  | Crosstalk Between Channels ${ }^{\text {(Note1) }}$ | CTC | - | -100 | -90 | dB | $\begin{aligned} & \mathrm{R}_{\mathrm{G}}=0 \Omega \\ & \mathrm{CT}=20 \text { log }\left(\mathrm{V}_{\text {out }} / \mathrm{V}_{\text {out }}\right) \\ & \mathrm{BW}=1 \mathrm{HF}-\mathrm{A} \end{aligned}$ |
|  | Maximum Attenuation ${ }^{\text {(Note1) }}$ | $\mathrm{G}_{\mathrm{Fmin}}$ | - | -100 | -90 | dB | $\begin{aligned} & \text { Fader Attenuation }=\quad-\infty \mathrm{dB} \\ & \mathrm{G}_{\mathrm{F}}=20 \log \left(\mathrm{~V}_{\text {out }} / \mathrm{V}_{\text {IN }}\right) \\ & \mathrm{BW}=1 \mathrm{HF}-\mathrm{A} \end{aligned}$ |
|  | Gain Set Error | $\mathrm{GF}_{\text {ERR }}$ | -2 | 0 | 2 | dB | $\begin{aligned} & \text { Fader Boost Gain } \\ & =\quad+1 \text { to }+23 \mathrm{~dB} \end{aligned}$ |
|  | Attenuation Set Error 1 | $\mathrm{G}_{\mathrm{FERR} 1}$ | -2 | 0 | 2 | dB | Fader Attenuation $=0 \text { to }-15 \mathrm{~dB}$ |
|  | Attenuation Set Error 2 | GFERR2 | -3 | 0 | 3 | dB | Fader Attenuation $=-16 \text { to }-47 \mathrm{~dB}$ |
|  | Attenuation Set Error 3 | $\mathrm{G}_{\text {ERR }}$ | -4 | 0 | 4 | dB | $\begin{aligned} & \text { Fader Attenuation } \\ & =\quad-48 \text { to }-79 \mathrm{~dB} \end{aligned}$ |
|  | Power Supply Rejection Ratio | RRvccı | - | -70 | -40 | dB | $\begin{aligned} & \mathrm{V}_{\mathrm{RR}}=0.1 \mathrm{~V}_{\mathrm{RMS}} \\ & \mathrm{f}_{\mathrm{RR}}=1 \mathrm{kHz} \\ & \mathrm{RR}_{\mathrm{vcCL}}=20 \log \left(\mathrm{~V}_{\text {OUT }} / \mathrm{V}_{\mathrm{CCL}}\right) \end{aligned}$ |
|  |  | RR vcch | - | -70 | -40 | dB | $\begin{aligned} & \mathrm{V}_{\mathrm{RR}}=0.1 \mathrm{~V}_{\mathrm{RMS}} \\ & \mathrm{f}_{R \mathrm{R}}=1 \mathrm{kHz} \\ & \mathrm{RR}_{\mathrm{VCCH}}=20 \log \left(\mathrm{~V}_{\text {OUT }} / \mathrm{V}_{\mathrm{CCH}}\right) \end{aligned}$ |
| $\begin{aligned} & \text { D } \\ & \stackrel{-\bar{x}}{x} \\ & \hline \end{aligned}$ | Input Impedance | $\mathrm{R}_{\text {In_M }}$ | 70 | 100 | 130 | k $\Omega$ |  |
|  | Maximum Input Voltage | VIM_M | 2.0 | 2.2 | - | $\mathrm{V}_{\text {RMS }}$ | $\mathrm{V}_{\text {Iм_м }}$ at $\mathrm{THD}+\mathrm{N}\left(\mathrm{V}_{\text {Out }}\right)=1 \%$ $B W=400-30 \mathrm{kHz}$ Input point=MIN |
|  | Maximum Attenuation ${ }^{(N o t e 1)}$ | $\mathrm{Gmx}_{\text {min }}$ | - | -100 | -85 | dB | $\begin{aligned} & \text { Front Mixing=OFF } \\ & \mathrm{G}_{\mathrm{Mx}}=20 \log \left(\mathrm{~V}_{\text {out }} / V_{\mathrm{IN}}\right) \\ & \mathrm{BW}=\mathrm{IHF}-\mathrm{A} \\ & \text { Input point=}=\mathrm{MIN} \end{aligned}$ |
|  | Mixing Gain | $\mathrm{G}_{\mathrm{MX}}$ | -2 | 0 | 2 | dB | Front Mixing=ON <br> $\mathrm{G}_{\mathrm{Mx}}=20 \log \left(\mathrm{~V}_{\text {out }} / \mathrm{V}_{\text {IN }}\right)$ - $\mathrm{G}_{\text {н(оUт) }}$ |
|  | Input Impedance | Rin_m | 70 | 100 | 130 | k $\Omega$ |  |
|  | Boost Gain | $\mathrm{GF}_{\text {BST }}$ | 4 | 6 | 8 | dB | $\begin{aligned} & \text { Gain Adjust=6dB } \\ & V_{\text {IN }}=0.1 V_{\text {RMS }} \\ & G_{F}=20 \log \left(V_{\text {OUT }} / V_{\text {IN }}\right)-G_{H(\text { OUT })} \end{aligned}$ |
|  | Channel Balance | CB | -1.5 | 0 | 1.5 | dB | $\mathrm{CB}=\mathrm{GV} 1-\mathrm{GV} 2$ |

(Note1) VP-9690A (Average value detection, effective value display) filter by Panasonic is used for measurement. Input and output are in-phase.

## Typical Performance Curve(s)



Figure 4. $\mathrm{V}_{\mathrm{Cc}} \mathrm{vs}$. $\mathrm{I}_{\mathrm{Q}} \mathrm{vccL}{ }^{+} \mathrm{I}_{\mathrm{Q}} \mathrm{vcch}$


Figure 6. Gain vs. frequency (Normal / High-Voltage mode)


Figure 5. $\mathrm{V}_{\mathrm{CCH}}$ vs. $\mathrm{I}_{\mathrm{Q}} \mathrm{VCCH}$ (High-Voltage mode)


Figure 7. THD+N vs. Vin / Vo (Gain Adjust=+6dB)


Figure 8. CMRR vs. frequency


Figure 10. PSRR vs. frequency


Figure 9. Crosstalk (between Channels) vs. frequency


Figure 11. Gain(LPF ON/pass) vs. frequency

## $I^{2} \mathrm{C}$-bus CONTROL SIGNAL SPECIFICATION

(1) Electrical specifications and timing for bus lines and I/O stages


Figure 12. Definition of Timing on the $\mathrm{I}^{2} \mathrm{C}$-bus

Table 1 Characteristics of the SDA and SCL bus lines for I ${ }^{2} \mathrm{C}$-bus devices

| Parameter |  | Symbol | Fast-mode ${ }^{2} \mathrm{C}$-bus |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max |  |
| 1 | SCL Clock Frequency |  | $\mathrm{f}_{\mathrm{SCL}}$ | 0 | 400 | kHz |
| 2 | Bus Free Time between STOP and START Condition | $\mathrm{t}_{\text {BUF }}$ | 1.3 | - | $\mu \mathrm{sec}$ |
| 3 | Hold Time (repeated) START condition. After this period, the first clock pulse is generated | $\mathrm{thri}_{\text {; StA }}$ | 0.6 | - | $\mu \mathrm{sec}$ |
| 4 | LOW Period of the SCL Clock | tıow | 1.3 | - | $\mu \mathrm{sec}$ |
| 5 | HIGH Period of the SCL Clock | $\mathrm{t}_{\text {HIGH }}$ | 0.6 | - | $\mu \mathrm{sec}$ |
| 6 | Set-up Time for a Repeated START Condition | tsu;STA | 0.6 | - | $\mu \mathrm{sec}$ |
| 7 | Data Hold Time | $\mathrm{t}_{\text {HD; }}$ DAT | 0* | - | $\mu \mathrm{sec}$ |
| 8 | Data Set-up Time | $\mathrm{t}_{\text {Su; DAT }}$ | 100 | - | nsec |
| 9 | Set-up Time for STOP Condition | tsu;sto | 0.6 | - | $\mu \mathrm{sec}$ |

$$
\text { All values referred to } \mathrm{V}_{\mathrm{IH}} \text { min. and } \mathrm{V}_{\mathrm{IL}} \text { max. Levels (see Table 2). }
$$

Table 2 Characteristics of the SDA and SCL I/O stages for $I^{2} \mathrm{C}$-bus devices

| Parameter |  | Symbol | Fast-mode ${ }^{2} \mathrm{C}$-bus |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max |  |
| 10 | LOW level input voltage: Fixed input levels |  | VIL | -0.5 | 1 | V |
| 11 | HIGH level input voltage: Fixed input levels | $\mathrm{V}_{\mathrm{IH}}$ | 2.3 | - | V |
| 12 | Pulse width of spikes, which must be suppressed by the input filter. | $\mathrm{tsp}^{\text {P }}$ | 0 | 50 | nsec |
| 13 | LOW level output voltage (open drain or open collector): At 3mA sink current | VoL1 | 0 | 0.4 | V |
| 14 | Input current each $1 / \mathrm{O}$ pin with an input voltage between 0.4 V and 0.9 VDD max. | 1 | -10 | 10 | $\mu \mathrm{A}$ |



SCL clock frequency:250kHz

Figure 13. $I^{2} \mathrm{C}$-bus data transmission timing
(2) $\quad I^{2} \mathrm{C}$-bus FORMAT

| MSB LSB |  | MSB |  | LSB | MSB | LSB |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| S | Slave Address | A | Select Address | A | Data | A | P |
| 1bit | 8bit | 1bit $\quad$ 8bit $\quad$ 1bit $\quad$ bbit$=$ Start condition (Recognition of start bit)$=$Recognition of slave address. 7 bits in upper order are optional.The least significant bit is "L" due to write format. |  |  |  |  |  |
|  | S |  |  |  |  |  |  |
|  | Slave Address |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |
|  | A | = ACKNOWLEDGE bit (Recognition of acknowledgement) |  |  |  |  |  |
|  | Select Address | = Selection of register that contain data on volume, bass and treble settings. |  |  |  |  |  |
|  | Data | = Data on every volume and tone to be stored in selected register. |  |  |  |  |  |
|  | P | = Stop condition (Recognition of stop bit) |  |  |  |  |  |

(3) $\quad 1^{2} \mathrm{C}$-bus Interface Protocol
1)Basic form

| S | Slave Address | A | Select Address | A | Data | A | P |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| MSB |  |  | LSB | MSB | LSB | MSB | LSB |

2) Automatic increment (Select Address increases (+1) according to the number of data.)

| S | Slave Address | A | Select Address | A | Data1 | A | Data2 | A | $\cdots$ | DataN | A | P |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| MSB | LSB | MSB | LSB | MSB | LSB | MSB | LSB |  | MSB | LSB |  |  |

(Example) (1) Data1 shall be set as data of address specified by Select Address.
(2) Data2 shall be set as data of address specified by Select Address +1 .
(3) DataN shall be set as data of address specified by Select Address $+\mathrm{N}-1$.
3) Configuration unavailable for transmission (In this case, only Select Address1 is set.)

| S | Slave Address | A | Select Address1 | A | Data | A | Select Address 2 | A | Data | A |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |

(Note)If any data is transmitted as Select Address 2 next to data, It is recognized as data, not as Select Address 2.
(4) Slave address
MSB

| A6 | A5 | A4 | A3 | A2 | A1 | A0 | R/W |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

(5) Select Address \& Data

| Items | Select Address (hex) | MSB | Data |  |  |  |  |  | LSB |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| Initial Setup 1 | 01 | Advanced Switch ON/OFF | 0 | Advanced Switch Time of Input Gain/Fader |  | 0 | High-Voltage Mode Select | 0 | 0 |
| Initial Setup 2 | 02 | 0 | 0 | Sub Selector |  | 0 | 0 | Rear Selector | Front Selector |
| Input Selector | 05 | 0 | 0 | 0 | 0 | Input Selector |  |  |  |
| Input Gain | 06 | 0 | 0 | Input Gain |  |  |  |  |  |
| Fader 1ch Front | 28 | Fader Boost Gain / Attenuation |  |  |  |  |  |  |  |
| Fader 2ch Front | 29 | Fader Boost Gain / Attenuation |  |  |  |  |  |  |  |
| Fader 1ch Rear | 2A | Fader Boost Gain / Attenuation |  |  |  |  |  |  |  |
| Fader 2ch Rear | 2B | Fader Boost Gain / Attenuation |  |  |  |  |  |  |  |
| Fader Center | 2 C | Fader Boost Gain / Attenuation |  |  |  |  |  |  |  |
| Fader Subwoofer | 2D | Fader Boost Gain / Attenuation |  |  |  |  |  |  |  |
| LPF Setup Mixing ON/OFF | 30 | Front Mixing ON/OFF | LPF fc | 0 | 0 | 0 | 0 | Sub <br> Gain <br> Adjust | Main <br> Gain <br> Adjust |
| Test Mode | F0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| System Reset | FE | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |

Advanced switch

Notes on data format

1. "Advanced switch" function is available for the hatched parts on the above table.
2. In case of transferring data continuously, Select Address flows by Automatic Increment function, as shown below.

3. Input selector that is not corresponded for "Advanced switch" function, cannot reduce the noise caused when changing the input selector. Therefore, it is recommended to turn on mute when changing these settings.
4. In case of setting to infinite "- $\infty$ " by using Fader when input selector setting is changed, please consider "Advanced switch" time

Explanation of each Select Address


Figure 14. Block diagram for explanation of Select Address

## Command Specification

$\square$ Initial Condition, $\quad 1 / 0$ Fixed value Do not send the data not designated

Select Address 01 (hex)

| Mode | MSB |  |  | High-Voltage Mode Select |  |  |  | LSB |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| High-Voltage mode2 $(+8.3 \mathrm{~dB})$ |  | 0 |  |  | 0 | 0 | 0 | 0 |
| High-Voltage mode1 $(+4.6 \mathrm{~dB})$ |  |  |  |  |  | 1 |  |  |


| Mode | MSB |  |  |  |  |  |  |  | Advanced Switch Time of Input Gain/Fader ${ }^{\text {(Note 1,2) }}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |  |
| 4.7 msec |  |  | 0 | 0 |  |  |  |  |  |
| 7.1 msec |  | 0 | 0 | 1 | 0 |  | 0 | 0 |  |
| 11.2 msec |  |  | 1 | 0 |  |  |  |  |  |
| 14.4 msec |  |  | 1 | 1 |  |  |  |  |  |

(Note1) Advanced switch time is Typ value. Max value is 1.4 times of Typ value.
(Note2) If changing Advanced switch time while Advanced switch function is activated, Advance switch time is changed immediately.

| Mode | MSB |  | Advanced Switch ON/OFF |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D7ote3) | D2 | D6 | D5 | D4 | D3 | D1 | D1 |
| OFF | 0 | 0 |  |  | 0 |  | 0 | 0 |
| ON | 1 | 0 |  |  |  |  |  |  |

(Note3) If Advanced switch ON/OFF is changed while Advanced switch function is activated, it will become effective from the next switching operation.
Select Address 02 (hex)

| Mode | MSB |  |  | Front Selector | DSB |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| Front | 0 | 0 |  |  | 0 | 0 |  | 0 |
| Inside Through | 0 |  |  | 1 |  |  |  |  |


| Mode | MSB |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |  |
| Rear | 0 | 0 |  |  | 0 | 0 | 0 |  |  |
| Front Copy | 0 |  |  | 1 |  |  |  |  |  |


| Mode ${ }^{(\text {Note4) }}$ | MSB |  |  | Sub Selector |  |  | LSB |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| OUTC(INS)/OUTS(INS) | 0 | 0 | 0 | 0 | 0 | 0 |  |  |
| OUTC(INR1)/OUTS(INR2) |  |  | 0 | 1 |  |  |  |  |
| OUTC (INC)/OUTS(INS) |  |  | 1 | 0 |  |  |  |  |
| Prohibition |  |  | 1 | 1 |  |  |  |  |

(Note4) $x x x(I N x x)$ : "xxx" means "Output terminal", "(INxx)" means "Output signal"

## Command Specification

$\square$ Initial Condition, 1/0
Fixed value
Do not send the data not designated

Select Address 05(hex)


List of active input terminal when set input selector

| Mode | Lch positive input terminal | Lch negative input terminal | Rch positive input terminal | Rch negative input terminal |
| :---: | :---: | :---: | :---: | :---: |
| A | $1 \mathrm{pin}(\mathrm{A} 1)$ | - | $2 \mathrm{pin}(\mathrm{A} 2)$ | - |
| B | $3 \mathrm{pin}(\mathrm{B} 1)$ | - | 4pin(B2) | - |
| C single | 5 pin(CP1) | - | $7 \mathrm{pin}(\mathrm{CP} 2)$ | - |
| D single | 8pin(DP1) | - | 10pin(DP2) | - |
| E single | 11pin(EP1) | - | 13pin(EP2) | - |
| F single | 14pin(FP1) | - | 17pin(FP2) | - |
| C diff. | $5 \mathrm{pin}(\mathrm{CP} 1)$ | $6 \mathrm{pin}(\mathrm{CN})$ | $7 \mathrm{pin}(\mathrm{CP} 2)$ | $6 \mathrm{pin}(\mathrm{CN})$ |
| D diff. | 8pin(DP1) | 9pin(DN) | 10pin(DP2) | 9pin(DN) |
| E diff. | 11pin(EP1) | 12pin(EN) | 13pin(EP2) | 12pin(EN) |
| F full-diff. | 14pin(FP1) | 15pin(FN1) | 17pin(FP2) | 16pin(FN2) |

## Command Specification

Initial Condition, 1/0 Fixed value Do not send the data not designated

Select Address 06 (hex)

| Mode | MSB |  | Input Gain |  |  |  |  | $\begin{gathered} \hline \text { LSB } \\ \hline \text { D0 } \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D7 | D6 | D5 | D4 | D3 | D2 | D1 |  |
| Prohibition | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
|  |  |  | : | : | : | : | : | : |
|  |  |  | 0 | 0 | 1 | 0 | 0 | 0 |
| +23dB |  |  | 0 | 0 | 1 | 0 | 0 | 1 |
| +22dB |  |  | 0 | 0 | 1 | 0 | 1 | 0 |
| +21dB |  |  | 0 | 0 | 1 | 0 | 1 | 1 |
| +20dB |  |  | 0 | 0 | 1 | 1 | 0 | 0 |
| +19dB |  |  | 0 | 0 | 1 | 1 | 0 | 1 |
| +18dB |  |  | 0 | 0 | 1 | 1 | 1 | 0 |
| +17dB |  |  | 0 | 0 | 1 | 1 | 1 | 1 |
| +16dB |  |  | 0 | 1 | 0 | 0 | 0 | 0 |
| +15dB |  |  | 0 | 1 | 0 | 0 | 0 | 1 |
| +14dB |  |  | 0 | 1 | 0 | 0 | 1 | 0 |
| +13dB |  |  | 0 | 1 | 0 | 0 | 1 | 1 |
| +12dB |  |  | 0 | 1 | 0 | 1 | 0 | 0 |
| +11dB |  |  | 0 | 1 | 0 | 1 | 0 | 1 |
| +10dB |  |  | 0 | 1 | 0 | 1 | 1 | 0 |
| +9dB |  |  | 0 | 1 | 0 | 1 | 1 | 1 |
| +8dB |  |  | 0 | 1 | 1 | 0 | 0 | 0 |
| +7dB |  |  | 0 | 1 | 1 | 0 | 0 | 1 |
| +6dB |  |  | 0 | 1 | 1 | 0 | 1 | 0 |
| +5dB |  |  | 0 | 1 | 1 | 0 | 1 | 1 |
| +4dB |  |  | 0 | 1 | 1 | 1 | 0 | 0 |
| +3dB |  |  | 0 | 1 | 1 | 1 | 0 | 1 |
| +2dB |  |  | 0 | 1 | 1 | 1 | 1 | 0 |
| +1dB |  |  | 0 | 1 | 1 | 1 | 1 | 1 |
| 0dB |  |  | 1 | 0 | 0 | 0 | 0 | 0 |
| -1dB |  |  | 1 | 0 | 0 | 0 | 0 | 1 |
| -2dB |  |  | 1 | 0 | 0 | 0 | 1 | 0 |
| -3dB |  |  | 1 | 0 | 0 | 0 | 1 | 1 |
| -4dB |  |  | 1 | 0 | 0 | 1 | 0 | 0 |
| -5dB |  |  | 1 | 0 | 0 | 1 | 0 | 1 |
| -6dB |  |  | 1 | 0 | 0 | 1 | 1 | 0 |
| -7dB |  |  | 1 | 0 | 0 | 1 | 1 | 1 |
| -8dB |  |  | 1 | 0 | 1 | 0 | 0 | 0 |
| -9dB |  |  | 1 | 0 | 1 | 0 | 0 | 1 |
| -10dB |  |  | 1 | 0 | 1 | 0 | 1 | 0 |
| -11dB |  |  | 1 | 0 | 1 | 0 | 1 | 1 |
| -12dB |  |  | 1 | 0 | 1 | 1 | 0 | 0 |
| -13dB |  |  | 1 | 0 | 1 | 1 | 0 | 1 |
| -14dB |  |  | 1 | 0 | 1 | 1 | 1 | 0 |
| -15dB |  |  | 1 | 0 | 1 | 1 | 1 | 1 |
| Prohibition |  |  | 1 | 1 | 0 | 0 | 0 | 0 |
|  |  |  | : | : | : | : | : | : |
|  |  |  | 1 | 1 | 1 | 1 | 1 | 1 |

## Command Specification

1 Initial Condition, $1 / 0$ Fixed value Do not send the data not designated

Select Address 28, 29, 2A, 2B, 2C, 2D (hex)

| Boost \& Attenuation | MSB |  |  | Fader Boost / Attenuation |  |  | LSB |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| Prohibition | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
|  | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
|  | : | : | : | : | : | : | : | : |
|  | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 0 |
| +23dB | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 1 |
| +22dB | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 0 |
| +21dB | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 1 |
| - | - | - | - | - | - | - | - | - |
| - | - | - | - | - | - | - | - | - |
| +10dB | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 0 |
| $+9 \mathrm{~dB}$ | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 1 |
| +8dB | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 0 |
| +7dB | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 1 |
| +6dB | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 0 |
| +5dB | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 1 |
| +4dB | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 0 |
| +3dB | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 1 |
| +2dB | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| +1dB | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| OdB | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| -1dB | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| -2dB | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| -3dB | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 1 |
|  | - |  |  |  | - : |  |  | - |
| -78dB | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 0 |
| -79dB | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 |
| Prohibition | 1 | 1 | 0 | 1 | 0 | 0 | 0 | 0 |
|  | : | : | : | : | : | : | : | : |
|  | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| $-\infty \mathrm{dB}$ | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |

## Details of Fader Boost / Attenuation

$\square$ Initial Condition,

| (dB) | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | (dB) | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| +23 | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 1 | -29 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 1 |
| +22 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 0 | -30 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 0 |
| +21 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 1 | -31 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 1 |
| +20 | 0 | 1 | 1 | 0 | 1 | 1 | 0 | 0 | -32 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 |
| +19 | 0 | 1 | 1 | 0 | 1 | 1 | 0 | 1 | -33 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 1 |
| +18 | 0 | 1 | 1 | 0 | 1 | 1 | 1 | 0 | -34 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 0 |
| +17 | 0 | 1 | 1 | 0 | 1 | 1 | 1 | 1 | -35 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 1 |
| +16 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | -36 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 0 |
| +15 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 1 | -37 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 1 |
| +14 | 0 | 1 | 1 | 1 | 0 | 0 | 1 | 0 | -38 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 0 |
| +13 | 0 | 1 | 1 | 1 | 0 | 0 | 1 | 1 | -39 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 1 |
| +12 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | -40 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 0 |
| +11 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 1 | -41 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 1 |
| +10 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 0 | -42 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0 |
| +9 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 1 | -43 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 1 |
| +8 | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | -44 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 0 |
| +7 | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | -45 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 1 |
| +6 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | -46 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 0 |
| +5 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | -47 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 1 |
| +4 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | -48 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 0 |
| +3 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | -49 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 1 |
| +2 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | -50 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 0 |
| +1 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | -51 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 1 |
| 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | -52 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 0 |
| -1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | -53 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 1 |
| -2 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | -54 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | 0 |
| -3 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | -55 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | 1 |
| -4 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | -56 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | 0 |
| -5 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | -57 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | 1 |
| -6 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | -58 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 0 |
| -7 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | -59 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 1 |
| -8 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | -60 | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 0 |
| -9 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | -61 | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 1 |
| -10 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | -62 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 0 |
| -11 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 1 | -63 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| -12 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | -64 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |
| -13 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 1 | -65 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 1 |
| -14 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | -66 | 1 | 1 | 0 | 0 | 0 | 0 | 1 | 0 |
| -15 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | -67 | 1 | 1 | 0 | 0 | 0 | 0 | 1 | 1 |
| -16 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | -68 | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 0 |
| -17 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | -69 | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 1 |
| -18 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | -70 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 0 |
| -19 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | -71 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 1 |
| -20 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | -72 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 0 |
| -21 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 1 | -73 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 1 |
| -22 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | -74 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 0 |
| -23 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | -75 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 1 |
| -24 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | -76 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 0 |
| -25 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | -77 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 1 |
| -26 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | -78 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 0 |
| -27 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | -79 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 |
| -28 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | $-\infty$ | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |

## Command Specification

$\square$ Initial Condition, $\quad 1 / 0$ Fixed value Do not send the data not designated
Select Address 30(hex)

| Mode | MSB |  | Main Gain Adjust | LSB |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 0dB |  |  | 0 | 0 | 0 | 0 |  | 0 |
| +6 dB |  |  | 0 |  |  |  |  |  |


| Mode | MSB |  |  | Sub Gain Adjust |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 0dB |  |  | 0 | 0 | 0 | 0 | 0 |  |
| +6 dB |  |  | 0 | 0 | 1 |  |  |  |


| Mode | MSB |  | LSB |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 70 kHz |  | 0 | 0 | 0 | 0 | 0 |  |  |
| PASS |  | 1 | 0 |  |  |  |  |  |


| Mode | MSB |  | Front Mixing ON/OFF | DSB |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| OFF | 0 |  | 0 | 0 | 0 | 0 |  |  |
| ON | 1 |  | 0 |  |  |  |  |  |

(6) About power on reset

It is possible for the reset circuit inside the IC to initialize when supply voltage is turned on. Please send data to all address as initial data when the supply is turned on, and turn on mute until all initial data are sent.

| Item | Symbol | Limit |  |  | Unit | Condition |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max |  |  |
| Rise time of VCCL | t RISE $^{25}$ | 250 | - | - | $\mu \mathrm{sec}$ | $\mathrm{V}_{\text {CCL }}$ rise time to 5V |
| VCCL voltage of <br> release power on <br> reset | V $_{\text {POR }}$ | - | 4.1 | - | V |  |

## (7) About start-up and power off sequence on IC

By setting the terminal voltage of HIVOLB and SEL, it is possible to change the output gain. At the same time, output DC voltage will also be changed at each mode.

| HIVOLB <br> Terminal Voltage | High-Voltage |
| :---: | :---: |
| GND to 1.0 V | ON |
| 2.3 V to VCCL | OFF |


| SEL <br> Terminal Voltage | High-Voltage mode |
| :---: | :---: |
| GND to 0.5 V | High-Voltage mode1 |
| 1.5 V to VCCL | High-Voltage mode2 |

Please set HIVOLB terminal voltage between the ranges showed by the above tables. If HIVOLB terminal is open, the terminal voltage will be set to 5 V due to the pull-up voltage inside the IC . In this case, the IC will be set to "High-Voltage OFF" mode. SEL terminal is 4.15 V due to the pull-up voltage inside the IC.
Output DC voltage and Output gain, that are changed by the combination of "HIVOLB" terminal and "SEL" terminal shows as the following table.

| VCCH <br> Supplied Voltage | 9 V |  | 11.5 V | 17 V |
| :---: | :---: | :---: | :---: | :---: |
| HIVOLB <br> Terminal Voltage | 5 V <br> (High-Voltage OFF) |  | OV <br> (High-Voltage ON) |  |
| SEL <br> Terminal Voltage | 0 V <br> (High-Voltage mode1) | Open (4.15 V) <br> (High-Voltage mode2) | 0 V <br> (High-Voltage mode1) | Open (4.15 V) <br> (High-Voltage mode2) |
| Output DC <br> Bias Voltage | 4.35 V | 5.6 V | 8.35 V |  |
| Level Shift <br> Output gain | 2 dB | 4.6 dB | 8.3 dB |  |

If HIVOLB terminal voltage is changed during its operation, Output DC voltage will be also changed shown as above. For reducing these variations, turn the power on after setting the status of the HIVOLB and SEL terminal according to the output gain. The start-up and power off sequence is shown next.


Figure 15. Normal mode(High-Voltage OFF) operation


Figure 16. High-Voltage mode operation (High-Voltage mode1 and mode2 common)

HIVOLB in the figure above is used to select the Output gain. This IC will become active-state by sending data of Select Address 01 (hex) on $I^{2} \mathrm{C}$-bus after 20 msec from that VCCL reaches over 7.0V. High-Voltage Output gain is selected by setting SEL terminal voltage and sending $I^{2} \mathrm{C}$-bus data. Therefore, this command must always be sent in the start-up sequence. In addition, "External MUTE" in the figure above is the recommended period that the muting is activated from outside the IC. In addition, the starting sequence of VCCL and VCCH does not have the limit, but please start VCCL earlier to reduce a pop noise.

For HIVOLB terminal, there is countermeasure taken for protection from voltage spikes. But, please take care that the output DC voltage may fluctuate, if the period of voltage spike is over 50 nsec .

## (8) About relations of power supply voltage and the DC-bias voltage

Output DC-bias voltage is decided by the regulator that is embedded in this IC, DC-bias does not fluctuate up to a constant level even if power supply voltage is lowered. The following graphs show the relationship between DC-bias voltage and power supply voltage.


Figure 17. $\mathrm{V}_{\mathrm{Cch}}$ vs DC Bias


Figure 18. $\mathrm{V}_{\mathrm{CCL}}$ vs DC Bias

## About advanced switch circuit

【1】 Advanced switch technology
$1-1$ ．Advanced switch effects
Advanced switch technology is ROHM original technology that can prevent from switching pop noise．If changing the gain setting（for example Fader）immediatery，the audible signal will become discontinuously and pop noise will be occured． This Advanced switch technology will prevent this discontinuous signal by completing the signal waveform and will significantly reduce the noise．


Figure 19．Advanced switch waveform

This Advanced switch circuit will start operating when the data is transmitted from microcontroller．
Advanced switch waveform is shown as the figure above．For preventing switching noise，This IC will operate optimally by internal processing after the data is transmitted from microcontroller．

However，sometimes the switching waveform is not like the intended form depends on the transmission timing． Therefore，below is the example of the relationship between the transmission timing and actual switching time．Please consider this relationship for the setting．

1－2．The kind of the Transferring Data
－Data setting that is not corresponded to Advanced switch
（（5）Select Address \＆data Data format without hatching）
There is no particular rule about transferring data．
－Data setting that is corresponded to Advanced switch ${ }^{\text {（Note1）}}$
（（5）Select Address \＆data Data format with hatching）
There is no particular rule about transferring data，but Advanced switch must follow the switching sequence as mentioned in【2】 as follows．
（Note1）The blocks that are corresponded Advanced switch are＂Input Gain＂，＂Fader＂and＂Front Mixing ON／OFF＂（In detail，please refer to（5）Select Address \＆data）．

【2】 Data transmission that is corresponded to Advanced switch

## 2-1. Switching time of Advanced switch

Switching time includes [Twait(Wait time)], [ $\operatorname{Tsft}(\mathrm{A} \rightarrow \mathrm{B}$ switching time $)]$ and $[T \mathrm{Tft}(\mathrm{B} \rightarrow \mathrm{A}$ switching time $)]$.
25 msec is needed per 1 switching. (Tsoft = Twait + 2 * Tsft, Twait=2.3msec, Tsft=11.2msec)


Figure 20. About Advanced switching time
In the figure above, Start/Stop state is expressed as "A" and temporary state is expressed as "B".
The switching sequence of Advanced switch consists of the cycle " $A$ (start) $\rightarrow B$ (temporary) $\rightarrow A$ (stop)". Therefore, switching sequence will not stop at $B$ state.
For example, switching is performed from A (Initial gain) $\rightarrow \mathrm{B}$ (set gain) $\rightarrow \mathrm{A}$ (set gain) when switching from initial gain to set gain. And switching time (Tsft) of $A \rightarrow B$ or $B \rightarrow A$ are equal.

## 2-2. Explanation on data transmission's timing and switching operation.

The following examples show the timing chart from data transmission to starting of switching.
Definition of example expression :
F1=Fader 1ch Front, F2=Fader 2ch Front, R1=Fader 1ch Rear, R2=Fader 2ch Rear
C=Fader Center, S=Fader Subwoofer, MIX=Front Mixing

- Transmission example 1

This is an example when transmitting data in same block with "enough interval for data transmission".
(enough interval for data transmission : $1.4 \times$ Tsoft *"1.4" includes tolerance margin.)


F1 output


Figure 21. Transmission example 1

- Transmission example 2
- This is an example when the transmission interval is not enough (smaller than "Transmission example 1").
- When the data is transmitted during first switching operation, the second data will be reflected after the first switching operation. In this case, there is no wait time (Twait) before the second switching operation.


F1 output


Figure 22. Transmission example 2

- Transmission example 3

This is an example when transmission interval is smaller than "Transmission example 2").
When the data is transmitted during the first switching operation, and transmission timing is just during $A \rightarrow B$ switching operation, the second data will be reflected at $\mathrm{B} \rightarrow \mathrm{A}$ switching term in case of Fader.


Figure 23. Transmission example 3
Please take care as follows when transmitting data to multiple channels.
It is possible that Lch and Rch in same block(Front/Rear/Center,Subwoofer) can be switched at the same timing.
For example, if the data transmission is set as the figure below, F1 and F2 can be switched at the same timing. (Data (1)is sent for F1 (Lch) and data (2is sent for F2 (Rch).)
Twait (designed to 2.3 msec ) is the wait time for starting switching.
Twait may change from 1.2 msec (Min.) to 4.6 msec (Max.) by considering tolerance margin.


Figure 24. The operation during multi-channels (Lch, Rch) data transmission (smaller than Twait interval).

Next, if data (2)is not transmitted during the Twait, the switching operation will be as the figure below.


Figure 25. The operation during multiple channels (Lch, Rch) data transmission (larger than Twait interval).

2-3. Multiple blocks data transmission timing and switching operation.
In case the data is transmitted to multiple blocks, the processing is performed internally by BS (Block state) unit. Starting order of Advanced switch is determined by BS unit.


Figure 26. Multi-blocks data transmission timing

There are no timing regulations of $I^{2} \mathrm{C}$-bus data transmission. But next switching will start after the end of the current switching. The timing of Advanced switch is depended, not on the order of data transmission, but on the order of the figure below. The blocks in the same group (For example, BS1, BS3) can start switching at the same time.


Figure 27. The turn of Advanced switch start

Transmission example 2
In case of that the transmission order is different with actual switching order.


Figure 28. In case of the transmission order is different with actual switching order
If the data of Front/Rear/Center setting is transmitted during the switching of Front, Rear and Center switching have priority over Front switching. In order to proceeding the switching starts as the data transmission order, please transmit the next data after the end of current switching.

Transmission example 3
If Refresh data that is same as current setting is transmitted, gain switching operation will not start.
The below figure shows the case of transmitting data after Refresh data.


Figure 29. In case of the transmission of Refresh data

## Application Example



Figure 30. Application Example
$\left(\begin{array}{l}\text { UNIT } \\ \text { RESISTANCE: } \Omega \\ \text { CAPACITANCE: } F\end{array}\right)$

## Notes on wiring

(1)Please connect the decoupling capacitor of a power supply as close as possible to GND.
(2Lines of GND shall be one-point connected.
(3)Wiring pattern of Digital unit shall be away from that of analog unit and crosstalk shall not be acceptable.
(4)Lines of SCL and SDA of $I^{2} \mathrm{C}$-bus shall not be parallel if possible. The lines shall be shielded, if they are adjacent to each other.
(5)Lines of analog input shall not be parallel if possible. The lines shall be shielded, if they are adjacent to each other.

I/O Equivalence Circuit

| Terminal No | Terminal Name | Terminal Voltage | Equivalence Circuit | Terminal Description |
| :---: | :---: | :---: | :---: | :---: |
| $\begin{gathered} 1 \\ 2 \\ 29 \\ 30 \\ 31 \\ 32 \\ 33 \\ 34 \\ 18 \end{gathered}$ | A1 <br> A2 <br> INC <br> INS <br> INR1 <br> INR2 <br> INF1 <br> INF2 <br> MIN | 4.15 V |  | A terminal for signal input <br> The input impedance is $100 \mathrm{k} \Omega($ Typ $)$. |
| 3 <br> 4 <br> 5 <br> 6 <br> 7 <br> 8 <br> 9 <br> 10 <br> 11 <br> 12 <br> 13 <br> 14 <br> 15 <br> 16 <br> 17 | B1 <br> B2 <br> CP1 <br> CN <br> CP2 <br> DP1 <br> DN <br> DP2 <br> EP1 <br> EN <br> EP2 <br> FP1 <br> FN1 <br> FN2 <br> FP2 | 4.15V |  | Input terminal <br> Single/Differential mode is selectable. <br> The input impedance is $250 \mathrm{k} \Omega$ (Typ). |
| $\begin{aligned} & 27 \\ & 28 \end{aligned}$ | $\begin{aligned} & \text { IG2 } \\ & \text { IG1 } \end{aligned}$ | 4.15V |  | Input gain output terminal |
| $\begin{aligned} & 35 \\ & 36 \\ & 37 \\ & 38 \\ & 39 \\ & 40 \end{aligned}$ | OUTF2 <br> OUTF1 <br> OUTR2 <br> OUTR1 <br> OUTS <br> OUTC | (1) 4.35 V <br> (2) 5.6 V <br> (3) 8.35 V |  | Fader Output terminal <br> (1) Normal mode : 4.35 V <br> (2) High-Voltage mode1:5.6V <br> (3) High-Voltage mode2: 8.35V |

The figures in the pin explanation and input/output Equivalence circuit are reference values, it doesn't guarantee exact values.

| Terminal No | Terminal Name | Terminal Voltage | Equivalence Circuit | Terminal Description |
| :---: | :---: | :---: | :---: | :---: |
| 20 | HIVOLB | 5 V |  | Output gain control terminal <br> Low(0V supply) : High-Voltage ON High(terminal open) : High-Voltage OFF |
| $\begin{aligned} & 21 \\ & 26 \end{aligned}$ | $\begin{aligned} & \text { VCCH } \\ & \text { VCCL } \end{aligned}$ | $\begin{gathered} 17 / 11.5 / 9 \mathrm{~V} \\ 9 \mathrm{~V} \end{gathered}$ |  | Power supply terminal. |
| 22 | SCL | - |  | Terminal for clock input of $\mathrm{I}^{2} \mathrm{C}$-bus communication. <br> Note: When this pin is shorted to next pin(VCCH), it may result in property degradation and destruction of the device. |
| 23 | SDA | - |  | Terminal for data input of $I^{2} \mathrm{C}$-bus communication. |
| 24 | GND | OV |  | Ground terminal. |
| 25 | VREF | 4.15 V |  | BIAS terminal. <br> Voltage for reference bias of analog signal system. The simple precharge circuit and simple discharge circuit for an external capacitor are built in. |
| 19 | SEL | 4.15 V |  | High Voltage Output Select terminal <br> Low(0V supply) : High-Voltage mode1 High(terminal open) : High-Voltage mode2 |

The figures in the pin explanation and input/output Equivalence circuit are reference values, it doesn't guarantee exact values.

## Application Information

1) Absolute maximum rating voltage

When voltage is impressed to VCCL/VCCH exceeding absolute maximum rating voltage, circuit current increases rapidly and it may result in property degradation and destruction of a device. When impressed by a VCCL terminal (26pin) especially by surge examination etc., even if it includes an of operation voltage +surge pulse component, be careful not to impress voltage (about 14 V ) much higher than absolute maximum rating voltage. And, be careful that there is no more than 18 V on the VCCH terminal (21pin).
2) About a signal input part

In the signal input terminal, the value of the input coupling capacitor $C(F)$ should be sufficient to match the value of input impedance $\operatorname{RIN}_{\mathrm{IN}}(\Omega)$ inside the IC. The first HPF characteristic of CR is as shown below.



Figure 31. Input Equivalence Circuit
3) About output load characteristics

The usages of load for output are below (reference). Please use the load more than $10 \mathrm{k} \Omega(\mathrm{Typ})$.
Output terminal

| Terminal <br> No. | Terminal <br> Name | Terminal <br> No. | Terminal <br> Name | Terminal <br> No. | Terminal <br> Name | Terminal <br> No. | Terminal <br> Name |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 28 | IG1 | 36 | OUTF1 | 38 | OUTR1 | 40 | OUTC |
| 27 | IG2 | 35 | OUTF2 | 37 | OUTR2 | 39 | OUTS |




Figure 32. Output load characteristic at $\mathrm{V}_{\mathrm{CCL}}=9 \mathrm{~V}, \mathrm{~V}_{\mathrm{CCH}}=17 \mathrm{~V}$ (Reference)
4) About HIVOLB terminal(20pin) when power supply is off Any voltage shall not be supplied to HIVOLB terminal (20pin) when power-supply is off. Please insert a resistor (about $2.2 \mathrm{k} \Omega$ ) to HIVOLB terminal in series, in case voltage is supplied to HIVOLB terminal. (Please refer Application Circuit Diagram.)
5) About signal input terminals

Because the inner impedance of the terminal becomes $100 \mathrm{k} \Omega$ or $250 \mathrm{k} \Omega$ when the signal input terminal makes a terminal open, the plunge noise from outside sometimes becomes a problem. When there is an unused signal input terminal, design so it is shorted to ground.
6) About changing gain of Input Gain and Fader Volume

When increasing the input gain and fader volume, especially those exceeding 20 dB , the switching pop noise sometimes becomes big. In this case, we recommend changing the gain in 1 dB steps, without abruptly changing the gain at once. Also, the pop noise can sometimes be reduced by increasing the advanced switch time.
7) About inter-pin short to VCCH

VCCH terminal(21pin) is assumed at applied high voltage(Max 17.8 V ) for $5.2 \mathrm{~V}_{\mathrm{Rms}}(\mathrm{Max})$ output. And so, avoid short between VCCH and SCL. When Inter-pin shorts occur, circuit current increases rapidly, and it may result in property degradation and destruction of a device.

## Operational Notes

1. Reverse Connection of Power Supply

Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply, such as mounting an external diode between the power supply and the IC's power supply pins.
2. Power Supply Lines

Design the PCB layout pattern to provide low impedance supply lines. Separate the ground and supply lines of the digital and analog blocks to prevent noise in the ground and supply lines of the digital block from affecting the analog block. Furthermore, connect a capacitor to ground at all power supply pins. Consider the effect of temperature and aging on the capacitance value when using electrolytic capacitors.
3. Ground Voltage

Ensure that no pins are at a voltage below that of the ground pin at any time, even during transient condition.
4. Ground Wiring Pattern

When using both small-signal and large-current ground traces, the two ground traces should be routed separately but connected to a single ground at the reference point of the application board to avoid fluctuations in the small-signal ground caused by large currents. Also ensure that the ground traces of external components do not cause variations on the ground voltage. The ground lines must be as short and thick as possible to reduce line impedance.
5. Thermal Consideration

Should by any chance the maximum junction temperature rating be exceeded the rise in temperature of the chip may result in deterioration of the properties of the chip. In case of exceeding this absolute maximum rating, increase the board size and copper area to prevent exceeding the maximum junction temperature rating.
6. Recommended Operating Conditions

These conditions represent a range within which the expected characteristics of the IC can be approximately obtained. The electrical characteristics are guaranteed under the conditions of each parameter.
7. Inrush Current

When power is first supplied to the IC, it is possible that the internal logic may be unstable and inrush current may flow instantaneously due to the internal powering sequence and delays, especially if the IC has more than one power supply. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of connections.
8. Operation Under Strong Electromagnetic Field

Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.
9. Testing on Application Boards

When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

## Operational Notes - continued

10. Inter-pin Short and Mounting Errors

Ensure that the direction and position are correct when mounting the IC on the PCB. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground, power supply and output pin. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.
11. Unused Input Pins

Input pins of an IC are often connected to the gate of a MOS transistor. The gate has extremely high impedance and extremely low capacitance. If left unconnected, the electric field from the outside can easily charge it. The small charge acquired in this way is enough to produce a significant effect on the conduction through the transistor and cause unexpected operation of the IC. So unless otherwise specified, unused input pins should be connected to the power supply or ground line.
12. Regarding the Input Pin of the IC

This monolithic IC contains $\mathrm{P}+$ isolation and P substrate layers between adjacent elements in order to keep them isolated. P-N junctions are formed at the intersection of the P layers with the N layers of other elements, creating a parasitic diode or transistor. For example (refer to figure below):

When GND > Pin A and GND > Pin B, the P-N junction operates as a parasitic diode.
When GND > Pin B, the P-N junction operates as a parasitic transistor.
Parasitic diodes inevitably occur in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits, operational faults, or physical damage. Therefore, conditions that cause these diodes to operate, such as applying a voltage lower than the GND voltage to an input pin (and thus to the $P$ substrate) should be avoided.


Figure 33. Example of monolithic IC structure

## Ordering Information



## Marking Diagram



Physical Dimension, Tape and Reel Information
Package Name


## Revision History

| Date | Revision |  | Changes |
| :---: | :---: | :--- | :---: |
| 12.MAY.2016 | 001 | New Release |  |

## Notice

## Precaution on using ROHM Products

1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.
(Note1) Medical Equipment Classification of the Specific Applications

| JAPAN | USA | EU | CHINA |
| :---: | :---: | :---: | :---: |
| CLASSIII | CLASSIII | CLASS II b | CLASSIII |
|  |  | CLASSIII |  |

2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
[a] Installation of protection circuits or other protective devices to improve system safety
[b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
3. Our Products are not designed under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
[a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
[b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
[c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including $\mathrm{Cl}_{2}$, $\mathrm{H}_{2} \mathrm{~S}, \mathrm{NH}_{3}, \mathrm{SO}_{2}$, and $\mathrm{NO}_{2}$
[d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
[e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
[f] Sealing or coating our Products with resin or other coating materials
[g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
[h] Use of the Products in places subject to dew condensation
4. The Products are not subject to radiation-proof design.
5. Please verify and confirm characteristics of the final or mounted products in using the Products.
6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
8. Confirm that operation temperature is within the specified range described in the product specification.
9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

## Precaution for Mounting / Circuit board design

1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

## Precautions Regarding Application Examples and External Circuits

1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

## Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

## Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
[a] the Products are exposed to sea winds or corrosive gases, including $\mathrm{Cl} 2, \mathrm{H} 2 \mathrm{~S}, \mathrm{NH} 3, \mathrm{SO} 2$, and NO 2
[b] the temperature or humidity exceeds those recommended by ROHM
[c] the Products are exposed to direct sunshine or condensation
[d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

## Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

## Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

## Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

## Precaution Regarding Intellectual Property Rights

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[^0]:    (Note1) VP-9690A (Average value detection, effective value display) filter by Panasonic is used for measurement. Input and output are in-phase.

